







## DISCRIPTION

## **FEATURES**

Ferrite
High frequency design
Excellent Q values
Excellent SRF
High reliability
Excellent thermal stability

## **OPTIONS**

Tape & Reel is Standard (Qty: 3.000 Pcs)
Bulk Packing Available for smaller quantites
Tolerance: J = 5% and K=10% is Standard,
tighter Tolerance available (MOQ on request)

## **APPLICATIONS**

Modems
Mobile Radios
Cordless Telephones
Global Positioning Systems
Telecommunications Systems

## PHYSICAL CHARACTERISTICS

Testing: (Equivalents acceptable) Inductance & Q-HP4191A + HP4291A

SRF: HP8553B; RDC: 25°C
• Operating Temperature: -55°C ~ 85°C

Pad metalization : Silver-nickel with 90/10 solderSolder methods : Wave, Reflow, Vapor Phase

• Solderability: Max 260°C for 10 seconds

• Marking : EIA color code

## **ELECTRICAL SPECIFICATIONS**

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	18	μH	see Site 2
Q factor		Q	25		min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	2,1	Ω	max.
Self-Res. Freq.		SRF	45	Mhz	min.
Test-Freq.			2,52	Mhz	
Rated Current		IDC	210	mA	max.
Saturation Current		Isat		mA	typ.

1. This electronic component is meant to be used in general electronic equipment. Before the incorporation SMT WIRE-WOUND of this component into any equipment with higher and more reliable requirements such as aviation, **CHIP INDUCTORS** aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon -Components must be informed before the stage of design-in. Evaluation checks for safety have to be Part No.: S12008-180 performed on each electronic components used in electrical circuits that require high safety and reliability functions. Customer: DRW: Chang CHKD Young MATL: Chu Chi DATE 09.06.2009 APPD: **FINISH** Vienna 1 from 2 Pong Sheet



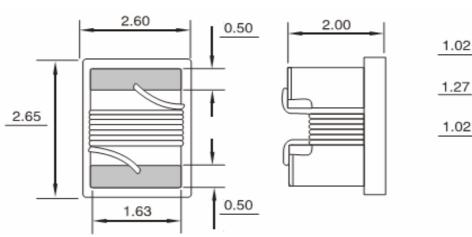


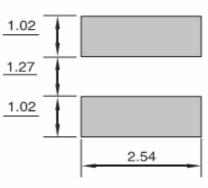




# **TECHNICAL INFORMATIONS**

## Dimensions ( mm )





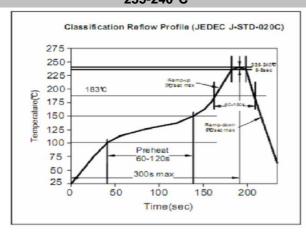
## **Ordering Information**

Serie and Range			
S12008-180			

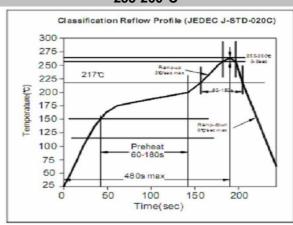
Tolerance	ROHS	Packing	
K	R	TR	

<b>J</b> = 5%	R = ROHS	<b>BU</b> = Bulk Ware
<b>K</b> = 10%	N = non ROHS	TR = Tape Reel
<b>M</b> = 20%		
<b>N</b> = 30%		

# Soldering Profile for Lead Free Soldering 235-240°C



# Soldering Profile for Lead Free Soldering 255-260°C



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functions.

CHIP INDUCTORS

Part No.: **\$12008-180** 

SMT WIRE-WOUND

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